



1 CHANNEL BIDIRECTIONAL TVS

Product Summary

V _{SB} Min	IPP Max	Ст тур
2.8V	5A	11pF

Description

Designed to replace multilayer varistors (MLVs) in portable applications where low operating voltage is vital, DIODES™ D3V3L1B2T offers superior electrical characteristics such as lower clamping voltage and no device degradation when compared to MLVs. D3V3L1B2T is designed to protect sensitive semiconductor components from damage or upset due to electrostatic discharge (ESD), lightning, electrical fast transients (EFT), and cable discharge events (CDE).

Applications

- Cellular handsets & accessories
- Notebooks & handhelds
- Portable instrumentation
- Digital cameras
- Peripherals
- MP3 players

Features

- Provides ESD Protection per IEC 61000-4-2 Standard : Air ±26kV. Contact ±26kV
- 1 Channel of ESD Protection
- Protects One Power or I/O Line
- Max. Peak Pulse Power: Ppp = 90W at tp = 8/20µs
- Low Clamping Voltage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e.: parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please refer to the related automotive grade (Q-suffix) part.
 A listing can be found at

https://www.diodes.com/products/automotive/automotive-products/.

 This part is qualified to JEDEC standards (as references in AEC-Q) for High Reliability.

https://www.diodes.com/quality/product-definitions/

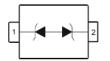
Mechanical Data

- Package: SOD523
- Package Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Alloy 42 Leadframe (Lead-Free Plating). Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.004 grams (Approximate)





Top View



Device Schematic

Ordering Information (Note 4)

Part Number	Daokago	Marking	Reel Size (inches)	Tana Width (mm)	Pa	cking
Fait Number	Package	ige warking	neer Size (iliches)	rape widin (ililii)	Qty.	Carrier
D3V3L1B2T-7	SOD523	V / A	7	8	3,000	Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



V / A = Product Type Marking Code

D3V3L1B2T Document number: DS44534 Rev. 1 - 2 1 of 5 www.diodes.com



Maximum Ratings (@ $T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Power Dissipation	P _{PP}	90	W	8/20µs, Per Figure 3
Peak Pulse Current	IPP	5	Α	8/20µs, Per Figure 3
ESD Protection – Contact Discharge	VESD_Contact	±26	kV	Standard IEC 61000-4-2
ESD Protection – Air Discharge	V _{ESD_Air}	±26	kV	Standard IEC 61000-4-2

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Package Power Dissipation (Note 5)	PD	250	mW
Thermal Resistance, Junction to Ambient (Note 5)	Reja	449.21	°C/W
Operating Temperature Range	TJ	-55 to +125	°C
Storage Temperature Range	Tstg	-55 to +150	°C
Soldering Temperature, t Max = 10s	T∟	+260	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Reverse Working Voltage	V_{RWM}	_	_	3.3	V	_
Reverse Current	I _R	_	0.05	0.5	μΑ	$V_R = V_{RWM} = 3.3V$
Punch Through Voltage	V _P T	3.5	_	_	V	$I_R = 2\mu A$
Snap-Back Voltage	VsB	2.8	_	_	V	I _R = 50mA
Deverse Clemning Veltage	V _{CL}	_	6.0	8.0	V	$I_{PP} = 1A, t_p = 8/20 \mu s$
Reverse Clamping Voltage		_	8.5	18	V	$I_{PP} = 5A, t_p = 8/20 \mu s$
Capacitance	Ст	_	11	15	pF	$V_R = 0V$, $f = 1MHz$

Note: 5. Device mounted on FR-4 PCB pad layout (2oz copper) as shown in Diodes Incorporated's package outline PDFs, which can be found on our website at http://www.diodes.com/package-outlines.html.



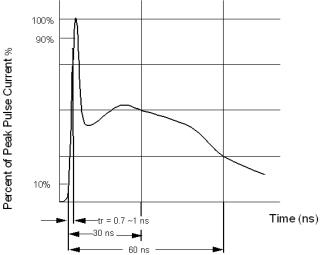


Figure 1. ESD Pulse Waveform According to IEC 61000-4-2

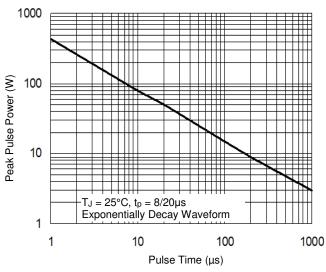


Figure 2. Power Dissipation Versus Pulse Time

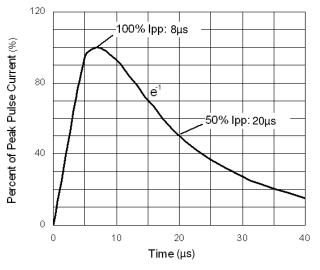


Figure 3. Typical 8 x 20µs Pulse Waveform

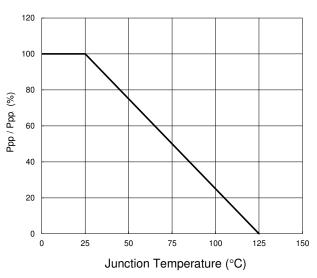


Figure 4. Peak Pulse Power Versus T_J

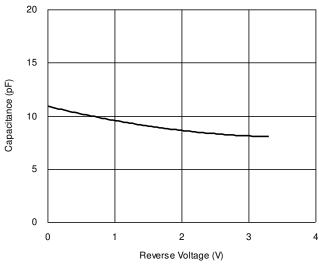


Figure 5. Typical Junction Capacitance

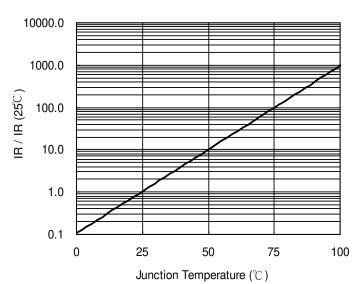


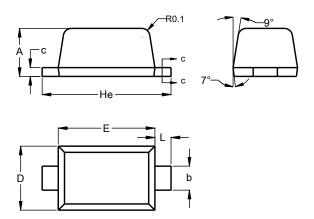
Figure 6. Reverse Leakage Current Versus TJ



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOD523

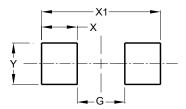


SOD523					
Dim	Min	Max			
Α	0.55	0.65			
Ь	0.26	0.34			
C	0.11	0.17			
D	0.75	0.85			
Е	1.15	1.25			
He	1.55	1.65			
L	0.10	0.30			
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOD523



Dimensions	Value (in mm)
G	0.80
Х	0.60
X1	2.00
٧	0.70



IMPORTANT NOTICE

- DIODES INCORPORATED (Diodes) AND ITS SUBSIDIARIES MAKE NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO ANY INFORMATION CONTAINED IN THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).
- The Information contained herein is for informational purpose only and is provided only to illustrate the operation of Diodes' products described herein and application examples. Diodes does not assume any liability arising out of the application or use of this document or any product described herein. This document is intended for skilled and technically trained engineering customers and users who design with Diodes' products. Diodes' products may be used to facilitate safety-related applications; however, in all instances customers and users are responsible for (a) selecting the appropriate Diodes products for their applications, (b) evaluating the suitability of Diodes' products for their intended applications, (c) ensuring their applications, which incorporate Diodes' products, comply the applicable legal and regulatory requirements as well as safety and functionalsafety related standards, and (d) ensuring they design with appropriate safeguards (including testing, validation, quality control techniques, redundancy, malfunction prevention, and appropriate treatment for aging degradation) to minimize the risks associated with their applications.
- Diodes assumes no liability for any application-related information, support, assistance or feedback that may be provided by Diodes from time to time. Any customer or user of this document or products described herein will assume all risks and liabilities associated with such use, and will hold Diodes and all companies whose products are represented herein or on Diodes' websites, harmless against all damages and liabilities.
- Products described herein may be covered by one or more United States, international or foreign patents and pending patent applications. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks and trademarks applications. Diodes does not convey any license under any of its intellectual property rights or the rights of any third parties (including third parties whose products and services may be described in this document or on Diodes' website) under this document.
- provided Diodes' products are subject tο Diodes' Standard Terms and Conditions of Sale (https://www.diodes.com/about/company/terms-and-conditions/terms-and-conditions-of-sales/) or other applicable terms. This document does not alter or expand the applicable warranties provided by Diodes. Diodes does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel.
- Diodes' products and technology may not be used for or incorporated into any products or systems whose manufacture, use or sale is prohibited under any applicable laws and regulations. Should customers or users use Diodes' products in contravention of any applicable laws or regulations, or for any unintended or unauthorized application, customers and users will (a) be solely responsible for any damages, losses or penalties arising in connection therewith or as a result thereof, and (b) indemnify and hold Diodes and its representatives and agents harmless against any and all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim relating to any noncompliance with the applicable laws and regulations, as well as any unintended or unauthorized application.
- While efforts have been made to ensure the information contained in this document is accurate, complete and current, it may contain technical inaccuracies, omissions and typographical errors. Diodes does not warrant that information contained in this document is error-free and Diodes is under no obligation to update or otherwise correct this information. Notwithstanding the foregoing, Diodes reserves the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. This document is written in English but may be translated into multiple languages for reference. Only the English version of this document is the final and determinative format released by Diodes.
- Any unauthorized copying, modification, distribution, transmission, display or other use of this document (or any portion hereof) is prohibited. Diodes assumes no responsibility for any losses incurred by the customers or users or any third parties arising from any such unauthorized use.
- 9. This Notice may be periodically updated with the most recent version available at https://www.diodes.com/about/company/terms-andconditions/important-notice

DIODES is a trademark of Diodes Incorporated in the United States and other countries. The Diodes logo is a registered trademark of Diodes Incorporated in the United States and other countries. © 2022 Diodes Incorporated. All Rights Reserved.

www.diodes.com

5 of 5 July 2022 D3V3L1B2T © 2022 Copyright Diodes Incorporated. All Rights Reserved. Document number: DS44534 Rev. 1 - 2